

*Technologies for
high efficiency solar cells*

ECM Group

PV production equipment leader



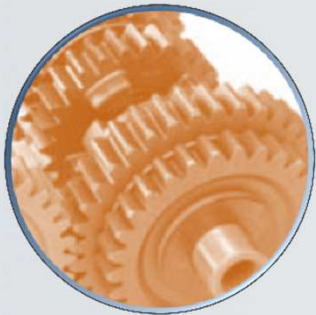
ECM Greentech
109 rue Hilaire de Chardonnet
38100 Grenoble - France

Benjamin Deneux | Sales Manager | Crystallization focus | 6th of September 2016

ECM GROUP

320 EMPLOYEES – 80 M€ REVENUES

AUTOMOTIVE NUCLEAR



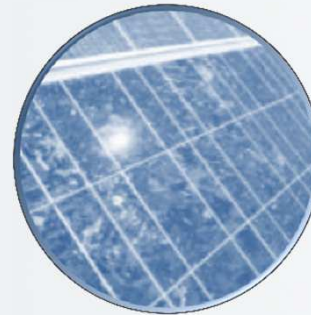
ICBP®
Vacuum furnace
Induction furnace
Special furnace

AEROSPACE



Conventional furnace
VPA furnace
Retrofit

PHOTOVOLTAICS



Ingot and cell production
equipment
Crystallization Furnace
Diffusion furnace
PECVD
Turnkey line

MICROELECTRONICS

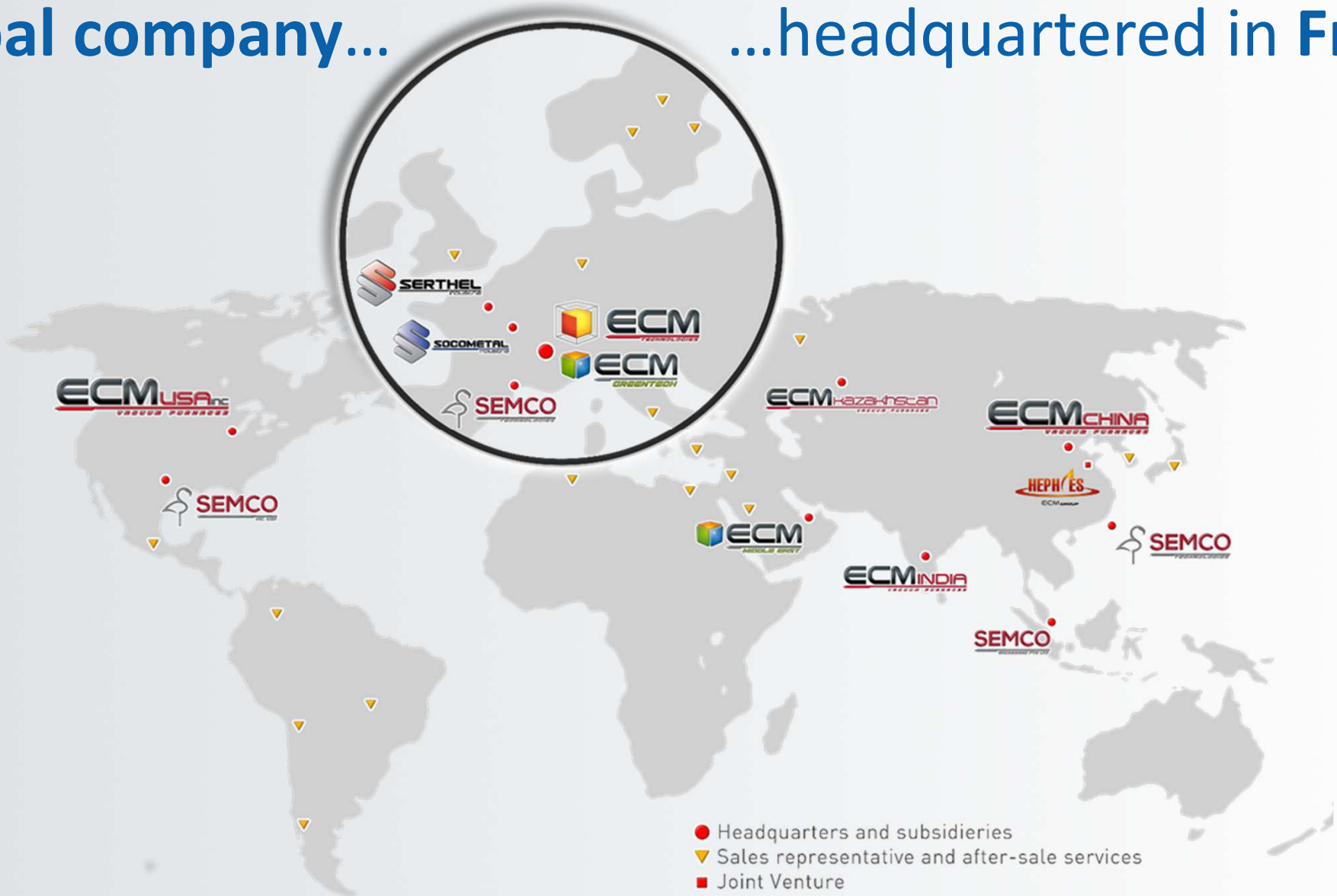


Photovoltaic
Silicon treatment
Electrostatic Chucks
Gas flow components

A global company...

...headquartered in France

- Offices in:
- France
 - USA
 - China
 - India
 - UAE
 - Kazakhstan
 - Singapore
 - Taiwan





ECM
TECHNOLOGIES

8 000 m² of workshop

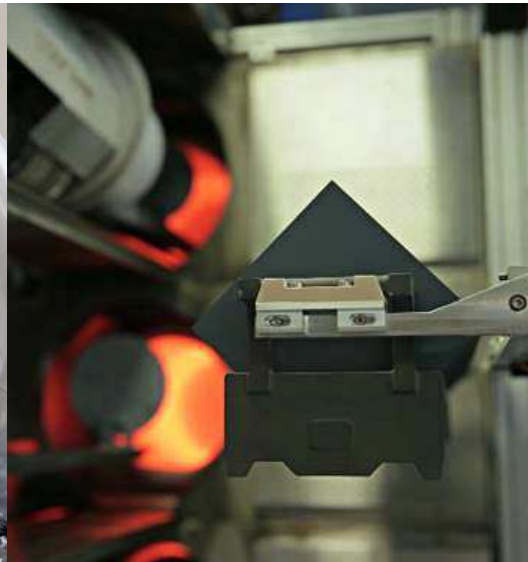
Boilermaking – Welding – Moly – Refractory brick lining – Piping – Machining –
Assembling

Engineering Office

Expertise Process – Electronical Automatism – Mecanic – Thermal

2 metallurgical testing facilities

In France and in US



ECM GREENTECH

1 agency in Grenoble

SEMCO Technologies

2 agencies in Montpellier, North and South

1 000 m² of workshop

Engineering Office

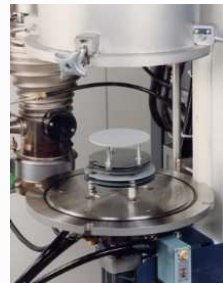
Process Expertise – Electrical Automatism – Mechanical – Thermal

1 Laboratory of equipment development and clean room process

ECM: A leading vacuum furnace maker



- **>3000** vacuum furnaces in production (Photovoltaic, automotive, aeronautic, electronic, nuclear)
- **1000 carburizing ICBP Cells** in the automotive industry (WORLD LEADER)
- More than **50 crystallization furnaces** in the field (France, China, Germany, Norway, Kazakhstan). Expert in Silicon crystallization since **1983**



Heat treatment experts since 1928...

DESIGN

BUILD

DEVELOP PROCESS

TRANSFER
TECHNOLOGY

LONG TERM SUPPORT

References crystallization furnace



*New furnaces delivered in 2016

Reference in PV turnkey line



ECM has successfully delivered and started up an ingot and wafer manufacturing line in Kazakhstan

Technology: **Multicrystalline**

Capacity: **60MW**, extendable to 100MW

Location: **Ust-Kamenogorsk, Kazakhstan**

Contract type: **Turnkey**



Reference in PV turnkey line



ECM is the only equipment supplier whom has successfully delivered such I&W line.



Reference in PV turnkey line



ECM PV600 : Crystallization furnace



ECM Furnace

3 processes

3 sizes



Std. multi

G5 25 Bricks

HP multi

G6 36 Bricks

CrystalMax: Ultra High Performance multi

G8 64 Bricks

CONFIDENTIAL

CRYSTALMAX: Ultra High Performance

<100> oriented wafers at the cost of multicrystalline



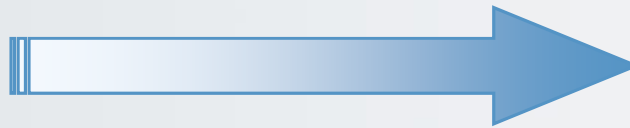
Traditional technologies:



Multicrystalline- 450Kg
Low cost
Average efficiency



Monocrystalline - 180Kg
High cost
High performance



INNOVATION ECM:



>20,5%
Cell efficiency

CrystalMax - 650Kg
Low cost
High performance

CONFIDENTIAL



R&D Partner: CEA INES



CRYSTALMAX is a technology jointly developed with the leading solar institute **CEA INES**



ines
INSTITUT NATIONAL
DE L'ENERGIE SOLAIRE



400 researchers dedicated to photovoltaics

Furnace productivity for CrystalMax



ECM PV 600 CrystalMax



Furnace output	≥11 MW per year Assuming 20% cell efficiency and 190μm thickness for mono wafers with 120μm kerf
Ingot size	100 x 100 cm ²
Ingot weight	650 Kg
Mass ingot yield (MIY)	≥63%
Cycle time	≤78 hrs



Crystalmax

A **1 GW** mono wafer line would require about **330** Czochralski pullers
or **only 90 ECM furnaces** with the CrystalMax process

CrystalMax production ingots



CONFIDENTIAL

CRYSTALMAX: Ultra high efficiency

<100> oriented wafers at the cost of multicrystalline



Cell technology	Efficiency average with CrystalMax	Maturity
Std Al BSF	19.0%	Production
PERC	>20.0%	Production
Bifacial n type	>20.0% + rear side	Production
HIT	21.3%	R&D

“CrystalMax wafers are oriented **<100>** which make it compatible with **alkaline etching**”

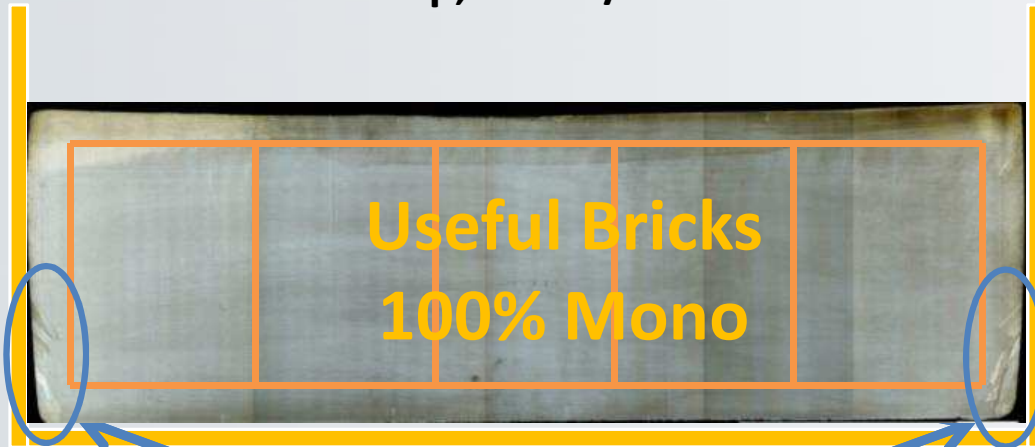
CrystalMax wafers are compatible with all **high efficiency cell processes**

Unique thermal control for growing mono ingot



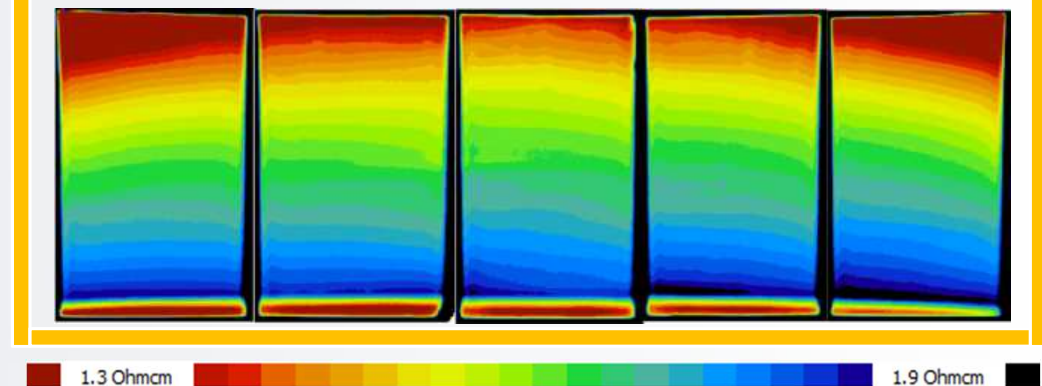
ECM design is unique on the market, achieving unmatched results in CrystalMax technology

Scan map, Mono/Multi %



Remaining multicrystalline Zone on the sides only.
The useful part of the bricks are 100% mono

Isoresistivity map (p type), representative of the solidification front



The resistivity mapping shows a uniform and slightly convex shape for the front of solidification which enables segregation of impurities on the sides and top part of the ingot and a proper control of initial crystal growth on mono seeds

CONFIDENTIAL

CrystalMax: Characterization Gen 6



Gen 6 ingot: 36 bricks $\langle 100 \rangle$

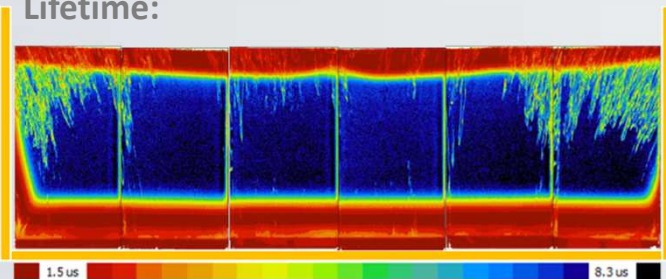
Visual:



100% of bricks oriented $\langle 100 \rangle$

→ *Reproducibility*

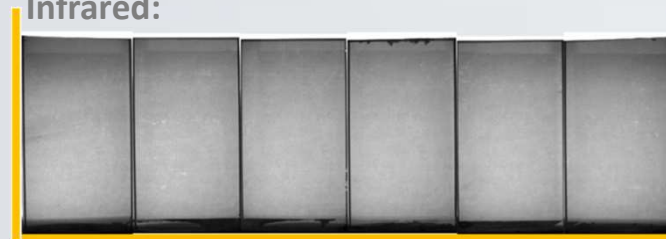
Lifetime:



Low dislocation density

→ *high cell efficiency*

Infrared:



IR defects free ingot

→ *Diamond slicing*

CrystalMax with diamond wafering



CrystalMax is a material which is compatible with **diamond** based wire sawing process.

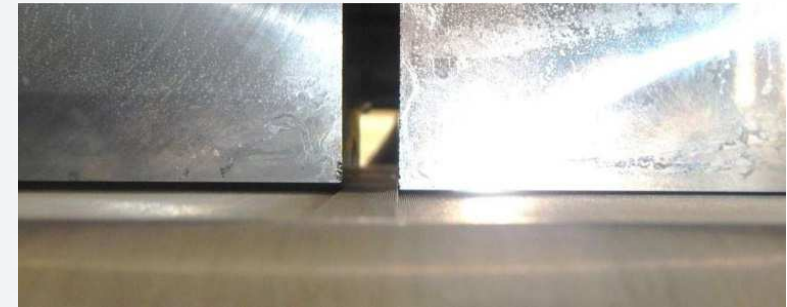
This enables CrystalMax to follow current and future **cost reductions** that roadmaps are displaying thanks to diamond cutting (thinner wafers, reduced kerf, reduced cost, no slurry management)

CrystalMax:

Inclusion free → **Easy cut with diamond**

<100> crystal orientation → **Alkaline texturing**

Monolike bricks cut on diamond platform

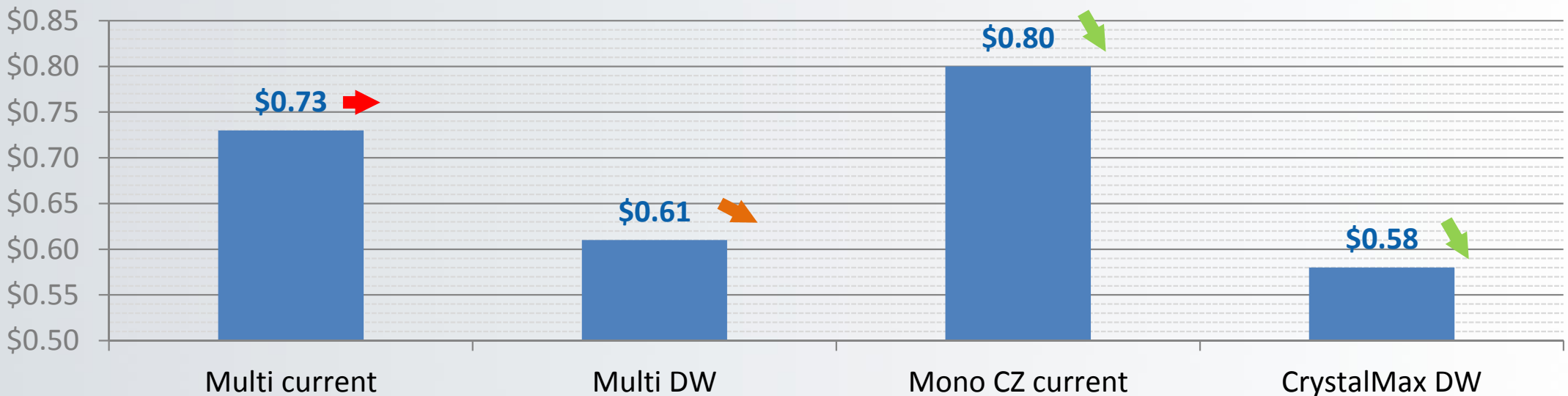


CrystalMax Competitiveness per wafer



Manufacturing cost per wafer (OPEX+CAPEX)

DW= Diamond wire wafering



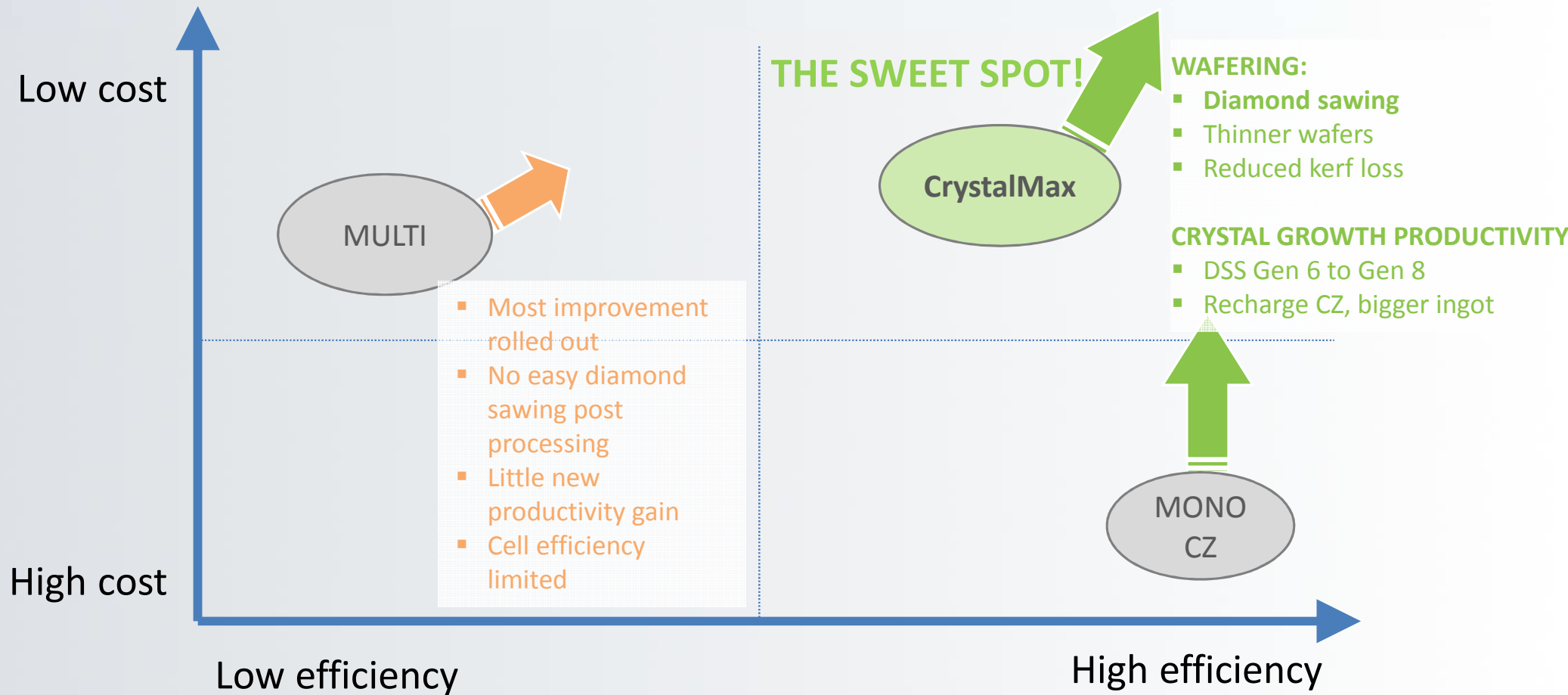
Multi current installed based stalling with slurry cutting = no to little cost improvement

Diamond wafering shows potential improvement for multi, yet not mature for mass production

Diamond wafering mature for mono ingot, being rolled out in the industry, but expensive crystallization cost

CrystalMax is mature for diamond wafering and has unmatched low crystallization cost structure compared to Mono CZ

Competitiveness mapping



Why invest in CrystalMax ?



ULTRA HIGH EFFICIENCY WAFER PROCESS: *A technology backed up by CEA-INES*

- Mono full square wafers **cheaper than multi** with ECM furnace
- **High cell efficiency** (e.g. >20% average in PERC)
- **Diamond** wafering solution + KOH texture (reduced kerf, thinner wafers, no slurry)
- **Automatic** process, easy to integrate in a new fab
- Enabling production of **n type** mono wafers for **bifacial** application
- **Low CAPEX** and **safe** investment (Flexible and high productivity multi furnace)
- **Highly productive furnace** = savings on building requirement, utilities and manpower

Our references in Photovoltaics...



Thank you

M. Benjamin DENEUX

Sales Manager

+33 6 30 92 61 22

b.deneux@ecmtech.fr



Photovoltaic Division
109 rue Hilaire de Chardonnet
38100 Grenoble
France